# Nitrogen8M Plus SMARC

i.MX 8M Plus + Wi-Fi 5 + Bluetooth 5.2 SMARC 2.1.1 Form Factor

### SECURE, SMART, STANDARDIZED, AND CONNECTED IOT: POWERFUL NXP EDGE PROCESSING WITH WI-FI 5 AND BLUETOOTH 5.2



**Boundary** Devices

a Laird Connectivity<sup>™</sup> company

and Sterling-LWB5+ (Infineon CYW4373E)

Up to 1.8 GHz quad-core Cortex-A53 and 800 MHz Cortex-M7

Featuring NXP i.MX 8M Plus

Wi-Fi 5 (802.11ac) and Bluetooth 5.2

Our customers asked for a high performance, robust SoM that simplifies their BOM, has reliable connectivity, uses a standard form factor, and is globally certified. One with multiple software options, a proven security architecture, long term software support, and security fixes.

Our new Nitrogen8M Plus SMARC is powered by NXP's innovative i.MX 8M Plus processor, NXP PMIC PCA9450, and our Sterling LWB5+ WiFi 5 / Bluetooth 5.2 radio based on Infineon's CYW4373E, high performance LPDDR4 RAM, and eMMC storage. We combine this with our common SMARC carrier board; together they serve as a single board computer (SBC) that can speed your product to market. Alternately, work with us to create a custom carrier that fits your mechanical, environmental, temperature, and interface requirements.

- Powerful Heterogenous Multiprocessing: Up to 1.8 GHz quad-core Cortex-A53 microprocessor and 800 MHz Cortex-M7 microcontroller allow you to run Linux and an RTOS on dedicated, hardware-firewalled subsystems.
- Dedicated Machine Learning: High-performance edge machine learning via an integrated neural processing unit, delivering up to 2.3 TOPS.
- Diversity of Interfaces: Multiple display, network, data, audio and camera interfaces.
- SMARC 2.1.1 Standard Form Factor: 82mm x 50mm SMARC edge connector form factor which includes onboard ethernet PHYs and a USB hub controller. One design supports multiple processor, memory, and wireless configurations.
- Hardware Upgrade Roadmap: Build a product design that can easily be upgraded to the latest processors and wireless options as future Laird Connectivity SOMs based on the SMARC standard are released.
- Advanced Common Carrier/Development Board: Display, camera, audio, Ethernet, USB, PCI-Express, CAN, I2C, SPI, UART, and more. Use in development, as an SBC equivalent in a product, or as reference designs for your carrier board design.

## FEATURES AT A GLANCE



#### **RELIABLE CONNECTIVITY: WI-FI 5 AND BT 5.2**

Excellent Wi-Fi and BT Classic / LE connectivity in difficult environments, plus enterprise Wi-Fi support via WPA3-Enterprise for more secure and robust connections.



### ML, GRAPHICS, VIDEO, VISION, AND AUDIO - UP TO 3 DISPLAYS

2.3 TOPS Machine Learning/Neural Processing Unit, up to 1200p60 or 4Kp30 displays, 2 shader GPU, 1080p60 multi codec encode and decode VPU, 2 MIPI-CSI camera interfaces, dedicated Image Signal Processing up to 12 MP, HiFi4 audio DSP

SECURE ENCLAVE AND SECURE BOOT POWERED BY I.MX 8M PLUS Dedicated on-board security hardware, secure boot Linux, and high-performance and flexible secure storage system for passwords, certificates, and data storage.





Choose from Yocto Linux, Android, and Ubuntu for the Cortex-A53s, Zephyr RTOS and FreeRTOS for the Cortex-M7

**ROBUST SOFTWARE AND SPEED TO MARKET** 



Carries several modular FCC, IC, CE, UKCA, RCM, MIC, KC and Bluetooth SIG approvals.

#### PERSONAL SUPPORT FROM DESIGN TO MANUFACTURE

Our industry-renowned support and field application engineering team is passionate about helping you speed your design to market.



- Wi-Fi 5 (802.11ac) and Bluetooth 5.2 Classic & Low Energy (LE)
- **Operating Temperate Range** Commercial Rating (0° to +70 °C) Industrial Rating (-40° to +85 °C)
- Multiple high performance memory options: 2GB LPDDR4 / 4GB LPDDR4 / 8GB LPDDR4 / 16GB eMMC 16GB eMMC 16GB eMMC (MOQ required)
- Extensive range of pre-certified antennas for Sterling-LWB5+
- US based manufacturing with Global Options: Manufacture in USA for local customer base and US market needs. Global manufacturing capability as part of Laird Connectivity footprint, growing reach to EMEA & APAC regions
- Diverse Software and Board Support Options: Choose from Yocto Linux/Buildroot Linux/Android/Ubuntu for Cortex-A53s, Zephyr RTOS/FreeRTOS for the Cortex-M7
- Secure and Encrypted Boot, Secure Enclave, and Secure File Storage: Robust, secure, and optionally encrypted boot mechanism to ensure only trusted software boots on your device. Optionally store and use secure keys, certificates, and credentials in run-time isolated trusted environment.
- Power Efficient: NXP PMIC, power optimized LPDDR4 and eMMC memory, core shut off, clock/voltage scaling, low power interfaces, power optimized single stream Wi-Fi mode enable highly optimized power consumption
- Long term hardware availability and software support: Laird Connectivity's products are specifically designed to meet the needs of the industrial and medical markets, which typically require 10 year or more product lifecycles. Long-term software support includes LTS Yocto Linux and Zephyr RTOS support with vulnerability remediation.











Industrial IoT, Vision Systems



Food and Beverage



**Medical Devices** 



### **KEY SPECIFICATIONS**

CATEGORY	FEATURE	SPECIFICATION
Processors	Microprocessor	4x Cortex®-A53 cores @ up to 1.8 GHz
	Microcontroller	1x Cortex®-M7 core @ 800 MHz
	Audio	Tensilica® HiFi 4 DSP
	Graphics	GC7000UL with 2 shaders for 3D and GC520L for 2D
	Machine Learning	Neural Processing Unit (NPU) with 2.3 TOP/s
Memory	RAM	2GB and 4GB. 8GB with qualifying MOQ. (For custom sizes, please contact Sales)
	Storage	16GB. (For custom sizes, please contact Sales)
Machine Learning	Neural Processing L	Jnit   Keyword detect, noise reduction, beamforming  Image recognition (i.e. ResNet-50)
		<ul> <li>Speech recognition (i.e. Deep Speech 2)</li> </ul>
Graphics and Video	Graphics Processing	g • 166 million triangles/sec • 16 GFLOPs 32-bit • 2D acceleration
	Unit	<ul> <li>1.0 giga pixel/sec</li> <li>OpenGL ES 1.1, 2.0, 3.0, OpenCL 1.2, Vulkan</li> </ul>
	Video Processing U	nit Video Decode Video Encode
		<ul> <li>1080p60 HEVC/H.265 Main, Main 10 (up to level 5.1)</li> <li>1080p60 AVC/H.264 encoder</li> </ul>
		<ul> <li>1080p60 VP9 Profile 0, 2</li> <li>1080p60 HEVC/H.265 encoder</li> </ul>
		<ul> <li>1080p60 VP8</li> </ul>
		<ul> <li>1080p60 AVC/H.264 Baseline, Main, High decoder</li> </ul>
	Display Interfaces	<ul> <li>1x MIPI DSI, up to UWHD and WUXGA</li> <li>1x HDMI 2.0a Tx, up to 4kp30</li> </ul>
		<ul> <li>1x LVDS Tx, up to 1920x1080p60</li> </ul>
Vision	Camera	1x 4-lane MIPI CSI
		1x 2-lane MIPI CSI
	Image Signal Proces	ssor 375 Mpixel/s HDR ISP supporting configurations, such as 12MP@30fps, 4kp45, or 2x 1080p80
Audio	Audio Interfaces	2x I2S (Optionally 1 as HDA)     ASRC
Peripherals	Input/Output	1x PCIe Gen3 1-Lane Dual Mode with PHY     3x UAR1 5 Mbit/s
		2X USB 3.0/2.0 WITH PHY     5X 12C     2X USB 3.0/2.0 WITH PHY     5X 12C     2X USB 3.0/2.0 WITH PHY     5X 12C     5X 12C
		ZX GDIL ELITETTEL WITH TEES 1568, AVB (OTER also     IX SDIO 3.0/EMINIC 5.1
		Supports (SN) - 14X GPIO
Wireless	W/i-Fi	Wi-Ei S (802 11ac)
Specification	Frequency	Ni 1-1 Store 1 4 GHz & 5 GHz
	Bluetooth	Rivetorit 5 2
	Transmit Power	+ 18 dBm (maximum)
	Antenna Ontions	Mile Commentaria for external antenna
	Raw Data Rates (Air	Wi-Fi 5 433 3Mbit/s - MCS9 80MHz 2560AM_SGI
Key Wi-Fi Features	Wi-Fi 5 (802,11ac)	IFFE 802 11 a/b/s/n/ac     OFDM
,		<ul> <li>20, 40 &amp; 80MHz bandwidth support</li> </ul>
Key Bluetooth	Bluetooth V	Classic Bluetooth – BR / EDR     Up to 7 Bluetooth LE connections
Features		Central / Peripheral Modes     LE Secure Connections
Supply Voltage		5 V
Physical	Dimensions	SMARC 2.1.1 Standard - 82mm x 50mm
Environmental	Temp Range	0°C to +70°C (Commercial) and -40° to +85 °C (Industrial)
Miscellaneous	Lead Free	Lead-free and RoHS-compliant
	Carrier Board	Carrier board, accessories, and evaluation software
Qualifications	Bluetooth <sup>®</sup> SIG	Bluetooth SIG Qualified Listing
Regulatory	Approvals	FCC/IC/CE/MIC/RCM
For full specifications on the Nitrogen8M Plus SMARC, please see the appropriate datasheet.		
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INVIVIP_SIVIARC_SOM	_21166MR	SIMARC SOLAT TIMIXAM QUELLER / ACD / ACCD / ANAC / LWES+
NBMP_SMARC_SOM	4r16eWB	SMARC SUM: I.MX8M Quad Plus / 4GB / 16GB eMMC / LWB5+
N8MP_SMARC_SOM	_2r16eWB_i	SMARC SOM: I.MX8M Quad Plus / 2GB / 16GB eMMC / LWB5+ / Industrial Temp
N8MP_SMARC_SOM	_4r16eWB_i	SMARC SOM: I.MX8M Quad Plus / 4GB / 16GB eMMC / LWB5+ / Industrial Temp
N8MP_SMARC_SOM	_8r16eWB	SMARC SOM: i.MX8M Quad Plus / 8GB / 16GB eMMC / LWB5+ (MOQ requirements)
SMARC_CAR_BRD		Universal Carrier Board - SMARC (Note - SOM sold separately)

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